

# Transient CHI Start-up in NSTX-U

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**<sup>1</sup>R. Raman, <sup>2</sup>D. Mueller, <sup>1</sup>B.A. Nelson, <sup>1</sup>T.R. Jarboe,  
and others**

**<sup>1</sup>University of Washington**

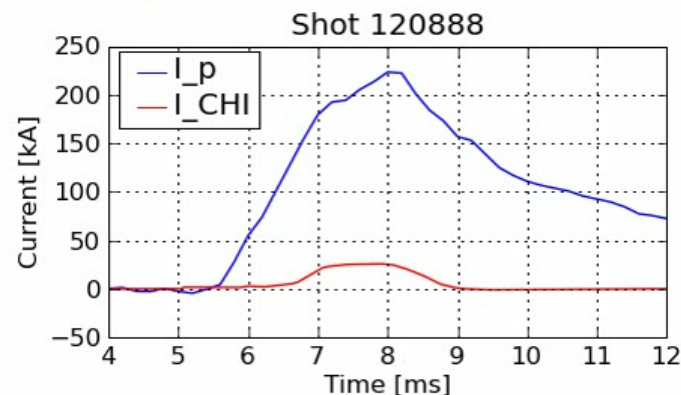
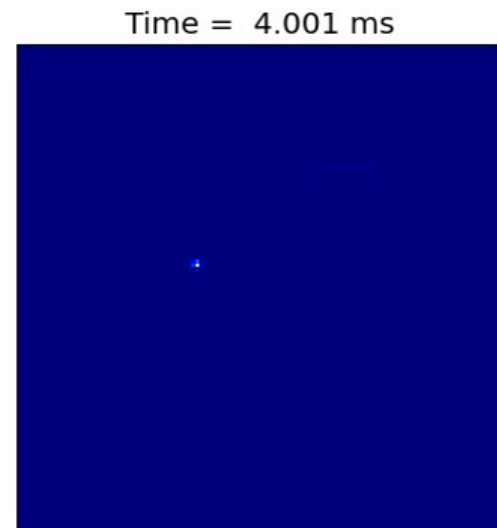
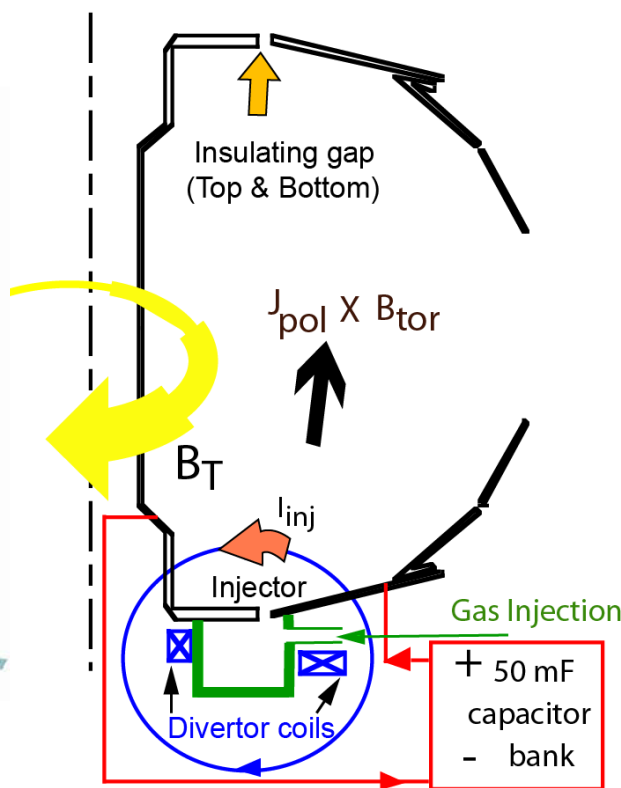
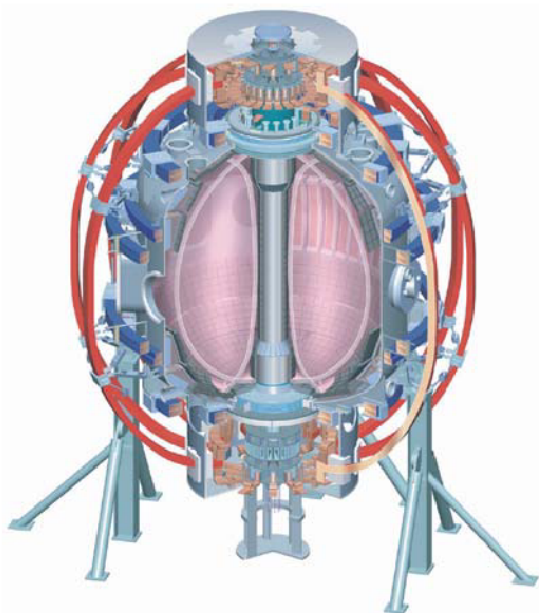
**<sup>2</sup>Princeton Plasma Physics Laboratory**

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**NSTX-U Research Forum  
PPPL, Princeton, NJ, February 24-27, 2015**

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# Transient CHI: Axisymmetric Reconnection Leads to Formation of Closed Flux Surfaces



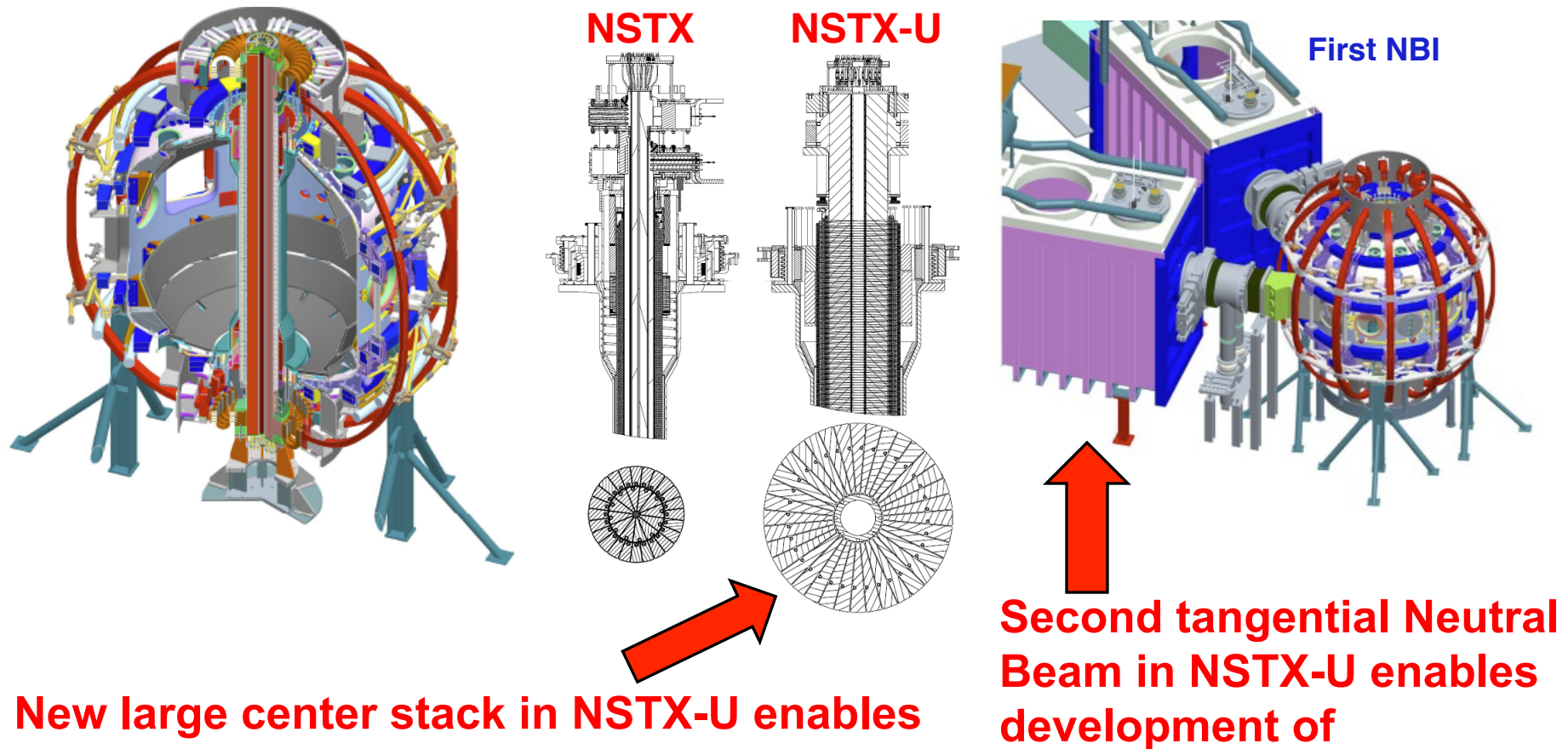
- Parameters to consider
  - Current multiplication factor
  - Effect of toroidal field
  - Magnitude of generated plasma current
  - New desirable features?

Fast camera: F. Scotti, L. Roquemore, R. Maqueda

CHI for an ST: T.R. Jarboe, Fusion Technology, 15 (1989) 7

Transient CHI: R. Raman, T.R. Jarboe, B.A. Nelson, et al., PRL 90, (2003) 075005-1

# NSTX-U Research will Advance the ST as a Candidate for a Fusion Nuclear Science Facility (FNSF)



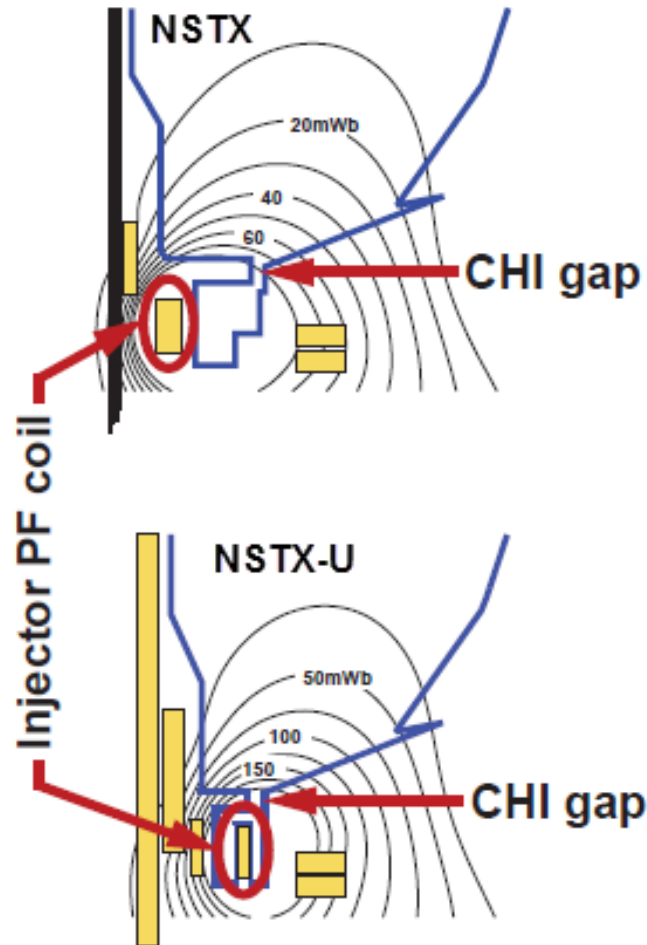
## New large center stack in NSTX-U enables

- $B_T$ : Increases from 0.55 to 1 T
- Plasma current: 1 to 2 MA
- Discharge pulse duration: 1s to 5 s

## Second tangential Neutral Beam in NSTX-U enables development of

- Non-inductive current ramp-up and 100% NI sustained operation

# CHI start-up to $\sim 0.4\text{MA}$ is projected for NSTX-U, and projects to $\sim 20\%$ start-up current in next-step STs



Injector flux in NSTX-U is  $\sim 2.5$  times higher than in NSTX  $\rightarrow$  supports increased CHI current

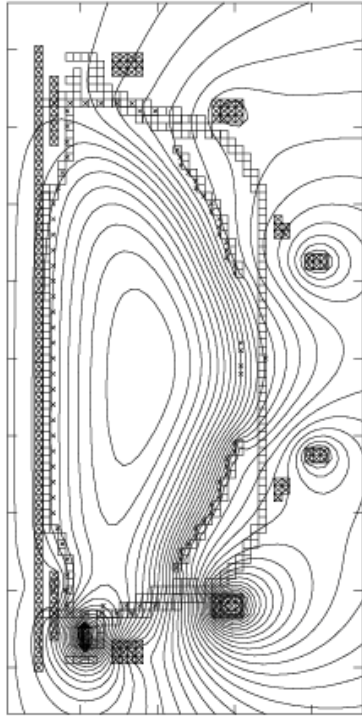
Parameters	NSTX	NSTX-U	ST-FNSF	ST Pilot Plant
Major radius [m]	0.86	0.93	1.2	2.2
Minor radius [m]	0.66	0.62	0.80	1.29
$B_T$ [T]	0.55	1.0	2.2	2.4
Toroidal flux [Wb]	2.5	3.9	15.8	45.7
Sustained $I_p$ [MA]	1	2	10	18
Injector flux (Wb)	0.047	0.1	0.66	2.18
Projected Start-up current (MA)	0.2	0.4	2.0	3.6

**Transient CHI Scaling:**  
Generated Toroidal Current is proportional to Injector Flux

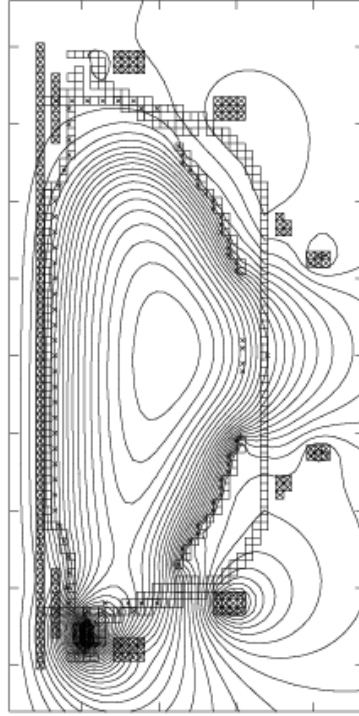


# CHI Produced Toroidal Current Increases with Increasing Levels of Current in the CHI Injector Coil (NSTX-U)

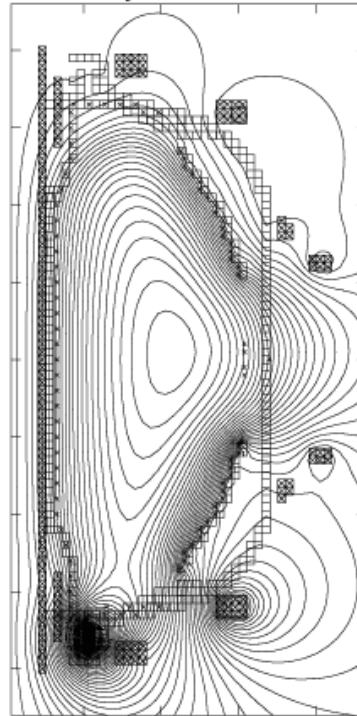
Poloidal Flux at 15 ms  
2 kA in Injector Coil



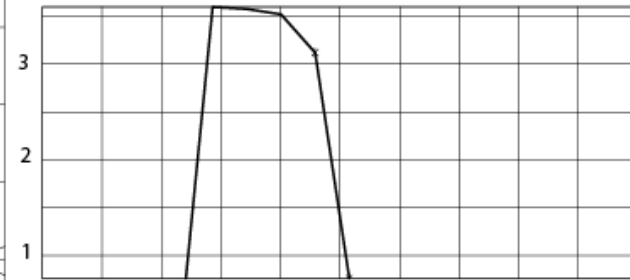
4 kA in injector Coil



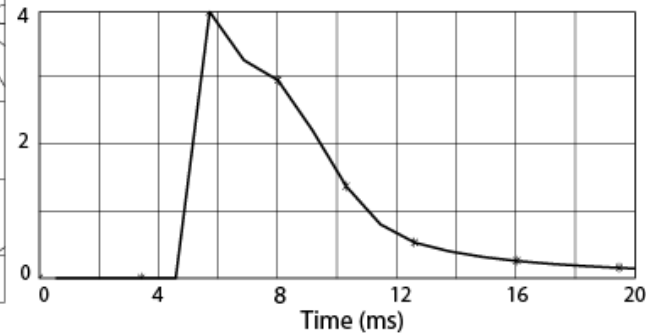
8 kA in Injector Coil



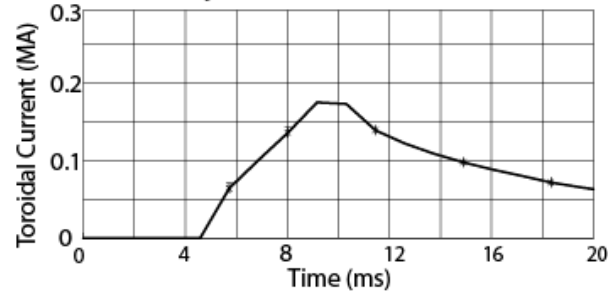
Representative Injector Voltage Waveform (Arbitrary Units)



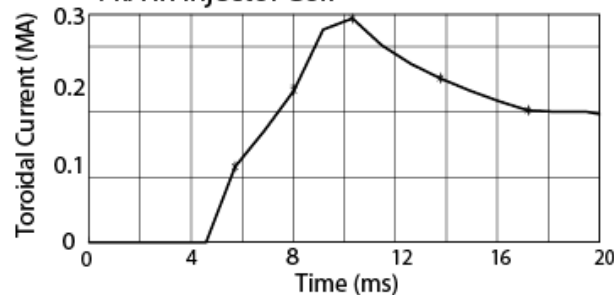
Representative Injector Current Waveform (Arbitrary Units)



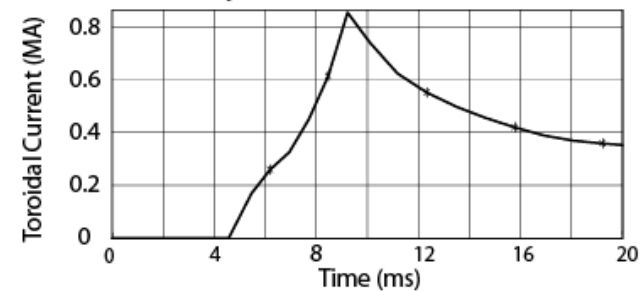
2 kA in Injector Coil



4 kA in injector Coil



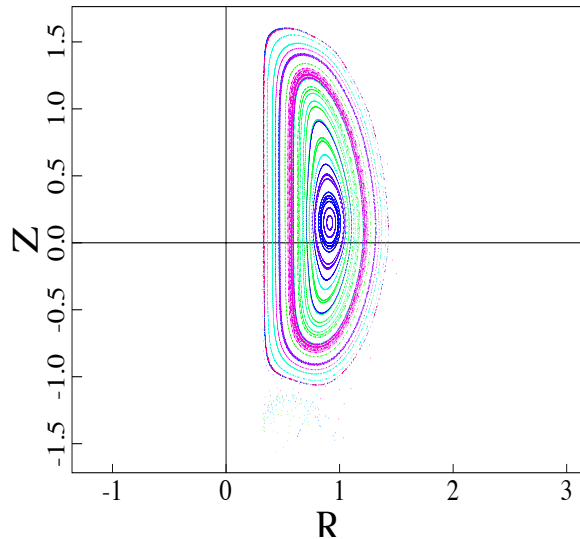
8 kA in Injector Coil



Raman, et al., IEEE Transactions on Plasma Science, Vol 42, No. 8 2154 (2014)

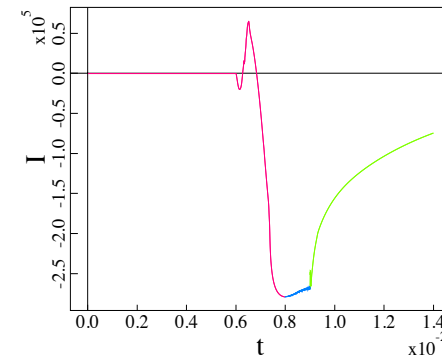
# Full flux closure is obtained in MHD simulations of NSTX-U

Surface of Section

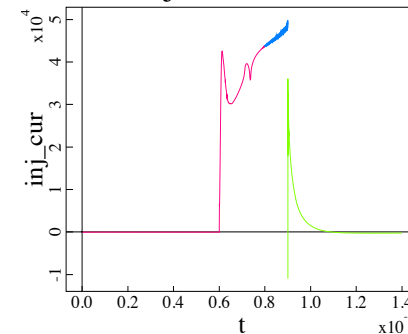


- Resistive MHD NIMROD simulations are performed in NSTX-U geometry at  $T_e \sim 15\text{eV}$ .
- Some features of reconnection process is similar to NSTX, i. e. closed flux surfaces expand in the NSTX global domain through a local Sweet-Parker type reconnection with an elongated current sheet in the injector region [F. Ebrahimi et al. PoP 2013, 2014]
- The fraction of closed flux current in NSTX-U is much higher (almost 100%) than what obtained in the simulations of NSTX.

Total and n=0 Tor. Current vs. t

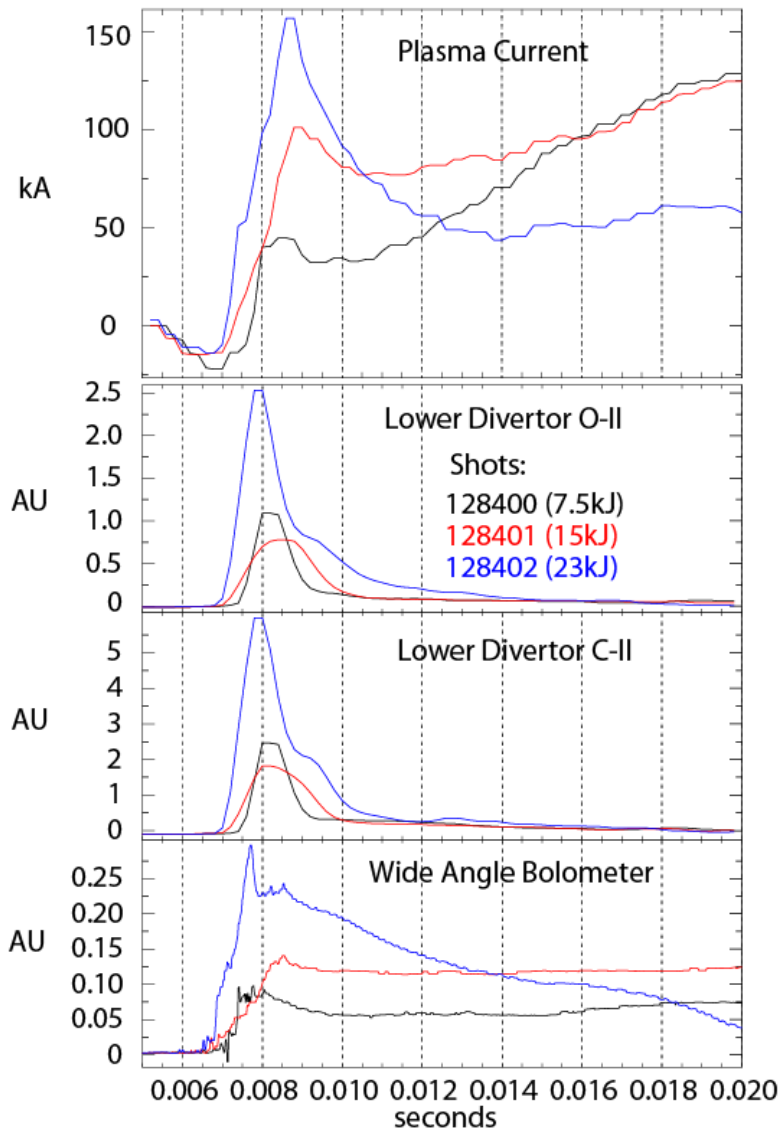


Injector current



NIMROD simulations (Ebrahimi)

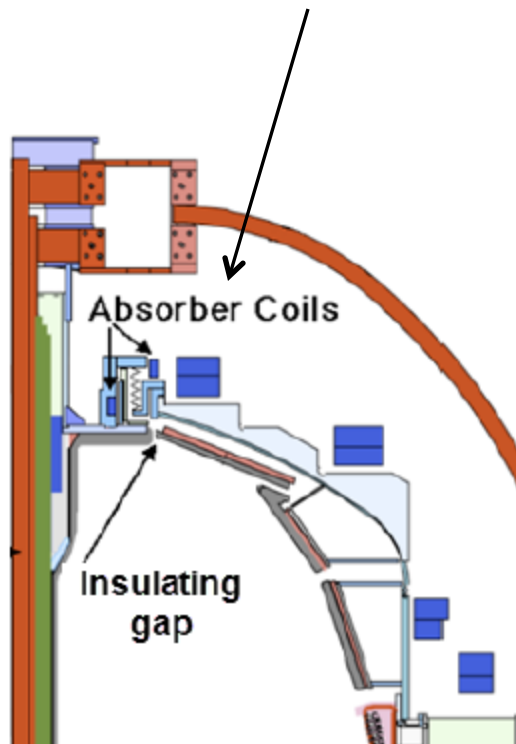
# Low-Z Impurity Radiation Needs to be Reduced for Inductive Coupling



- Low-Z impurity radiation increases with more capacitors
- Possible improvements
  - Metal divertor plates should reduce low-Z impurities
    - High Te in spheromaks (500eV) obtained with metal electrodes
  - Discharge clean divertor with high current DC power supply
  - Use auxiliary heating during the first 20ms

# Flux Savings on NSTX Now Realized After Low-Z Impurity Reduction

**Absorber coils provide  
buffer field**



Long-pulse (400ms) CHI discharges with high injector flux to avoid “bubble-burst”  
- ablate low-Z impurities from lower divertor

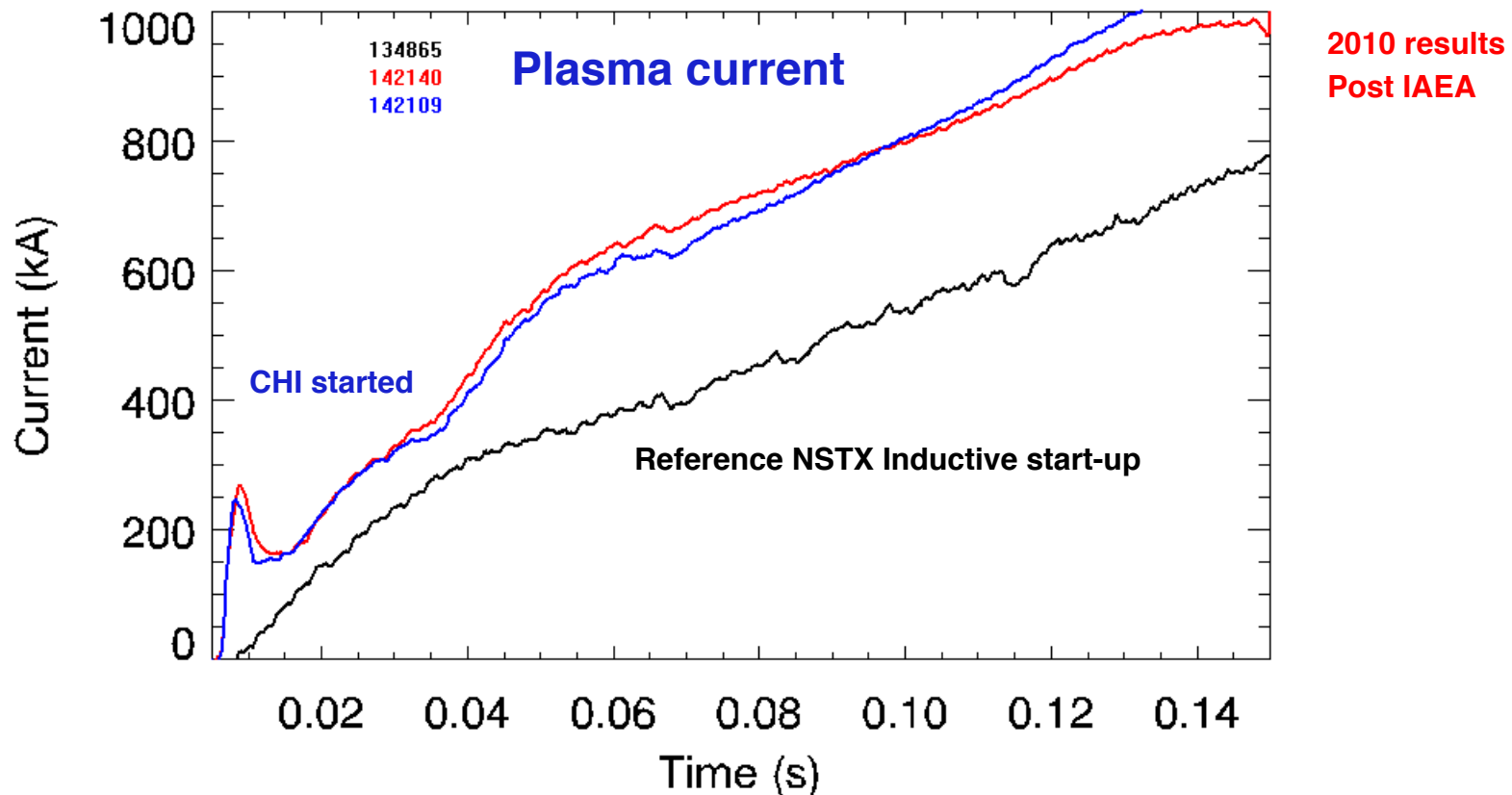
Deuterium glow discharge cleaning employed to chemically sputter and reduce oxygen levels

Lithium evaporation on lower divertor plates improved discharge performance

A buffer field was provided using new PF coils located in the upper divertor region  
- reduced interaction of CHI discharge with un-conditioned upper divertor plates



# Standard L-mode NSTX Discharge Ramps to 1MA Requiring 50% More Inductive Flux than a CHI Started Discharge



- Reference Inductive discharge
  - Uses 396mWb to get to 1MA
- CHI started discharge
  - Uses 258 mWb to get to 1MA (138 mWb less flux to get to 1MA)

# Experimental Plan for Establishing Transient CHI discharges on NSTX-U

- Start with  $BT \sim 0.5T$ , and  $PF1CL = 4kA$
- CHI gas injection at  $t = -13ms$ , at 2400Torr Plenum pressure
- Apply 1.5 to 2kV using the CHI cap bank configured for 10 mF to initiate the discharge.
- Adjust  $PF1C$ , so that discharge fills a good portion of the vessel
- Now, add currents in  $PF1AL$  and  $PF2L$  to shape the injector flux to make the footprint narrow. Add a small buffer field using  $PF1AU$ . Adjust the CHI voltage, gas injection amount, and if necessary the current in  $PF1CL$  to grow the plasma half way into the vessel without creating any absorber arcs.
- Add currents in  $PF5$  and  $PF3L$  and  $PF3U$  to keep the plasma away from the walls. Start with currents waveforms that were used in NSTX.

# Experimental Plan for Establishing Transient CHI discharges on NSTX-U

- After the discharge is able to reliably extend half-way into the vessel, increase the capacitor bank size in steps, to allow the discharge the fully fill the vessel.
- Increase the buffer filed magnitude in PF1CU, PF2U and PF1AU to keep the expanding plasma from contacting the upper divertor region.
- If necessary use the crowbar system in the capacitor bank to rapidly reduce the injector current
- Assess the level of current persistence obtained.
- Now readjust the time history of currents in PF1CL, PF2L and PF1AL to assess their impact on closed flux current generation.
- Once a reliable start-up scenario has been obtained, gradually increase the magnitude of the injector flux to increase the closed flux current magnitude.

## Systems Required

- Li evaporator to fully coat the lower divertor tiles
- Li coating of the upper divertor (if available)
- Capacitor Bank
- Upgraded MOV capability
- ECH for pre-ionization
- Both CHI gas injections systems
- Multiple view fast cameras (Fish eye view & lower divertor view with optical filters)
- Thomson, and diagnostics used for CHI on NSTX

## Run Time and Goals

- Based on NSTX experience, and noting that the CHI hardware configuration on NSTX-U has important differences compared to NSTX, estimate 4 run days.
- Progress will be made with any amount of run time, but CHI configuration on NSTX-U has important differences compared to NSTX
  - Also, time between shots will increase from 10 minutes to 20 minutes, effectively reducing to every day shot count by half compared to that in NSTX
- Goal is to establish 200kA in FY15 & 400kA in FY16.
- 200 kA target is adequate to proceed with inductive current ramp-up experiments, & test HHFW heating
- Also, provides good target for reconnection studies, and other experiments that need CHI capability